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# Applications of Accelerated Molecular Dynamics in Materials Science

Blas Pedro Uberuaga

*Los Alamos National Laboratory*



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# Acknowledgements

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- **Art Voter** (LANL)
- **Radiation damage in MgO:**
  - Kurt Sickafus (*now at University of Tennessee*)
  - Robin Grimes and Antony Cleave (*Imperial*)
  - Roger Smith and Pravesh Bacorisen (*Loughborough*)
  - Francesco Montalenti (*now at University of Milano*)
  - Graeme Henkelman (*now at University of Texas, Austin*)
- **Void evolution:**
  - Steve Valone and Richard Hoagland (*LANL*)
- **Stretched nanostructures**
  - Steve Stuart (*Clemson*)
  - Chun-Wei Pao (*now at Academia Sinica*)
  - Danny Perez and Sriram Swaminarayan (*LANL*)



**Funding:** BES, CMIME EFRC, LANL LDRD, Enhanced Surveillance

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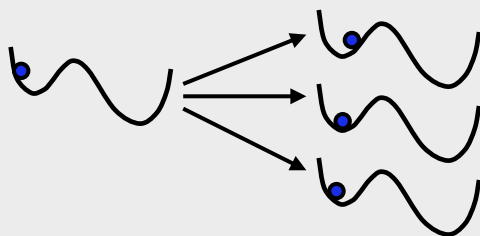
# Brief Introduction to Accelerated Molecular Dynamics

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- Many processes occur on much longer timescales than accessible via MD (ps-ns- $\mu$ s)
  - e.g. surface growth
  - radiation damage annealing
  - mass transport
  - etc.
- Need method to reach experimentally relevant timescales
- Three accelerated dynamics methods developed at LANL (Art Voter's team)
  - Parallel-Replica Dynamics
  - Hyperdynamics
  - Temperature Accelerated Dynamics (TAD)

# Accelerated Molecular Dynamics Methods

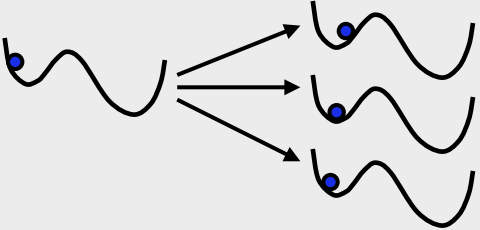
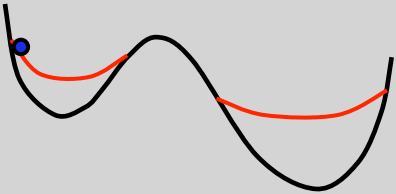
## Parallel Replica Dynamics (1998)



Explore basin with many processors  $M$  such that

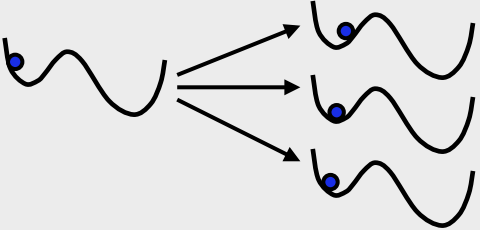
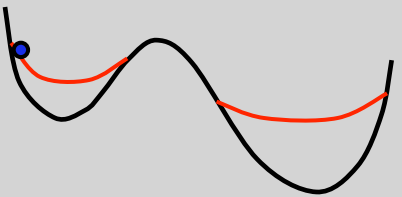
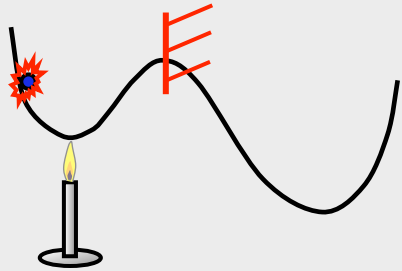
$$M \sim \tau_{\text{rxn}} / 1 \text{ ps}$$

# Accelerated Molecular Dynamics Methods

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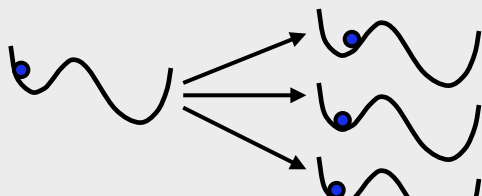
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<p><b>Hyperdynamics (1997)</b></p> 	<p>Increase rate by reducing effective barriers</p>
<p><b>Temperature Accelerated Dynamics (2000)</b></p> 	<p>Increase rate by raising temperature</p>

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# Accelerated Molecular Dynamics Methods

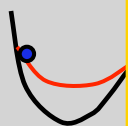
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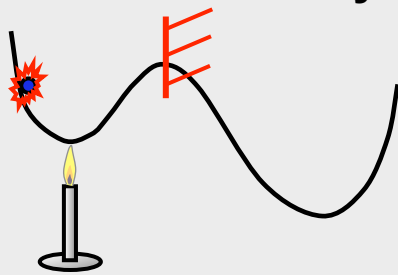
## Hyperdynamics



### Common Themes:

- *reduce waiting time for a transition to order of picoseconds*
- *let the trajectory find an appropriate way out of state, but coax it into doing so more quickly*

## Temperature Acceleration



temperature

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## Demonstrations of AMD methods

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- Vacancy Void Annealing in Cu
- Defect Dynamics in MgO
- Strain-rate dependent behavior in wires and nanotubes



## Demonstrations of AMD methods

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**Common Theme:**  
***Examples where achieving long times in atomistic simulations provided critical insight***

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A Parallel-Replica Study

# VACANCY VOID ANNEALING IN CU



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Beyond MD, Dresden, Germany -- 30-Apr-12 -- no. 10



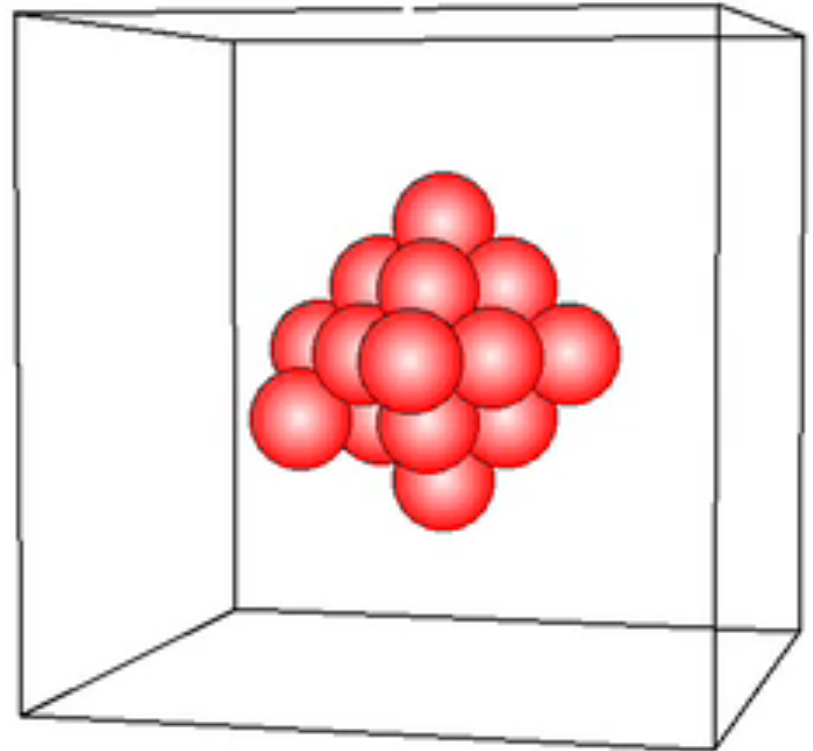
# Vacancy void annealing in Cu

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- Goal:
  - Understand vacancy aggregation/void formation
  - Probe kinetics of vacancy voids
- Method:
  - Parallel-replica dynamics: explore long-time behavior of voids
  - Molecular dynamics: obtain statistics on possible pathways
  - Nudged elastic band (molecular statics): characterize pathways
- Reference:
  - Uberuaga, Voter, Hoagland, and Valone, PRL **99**, 135501 (2007).

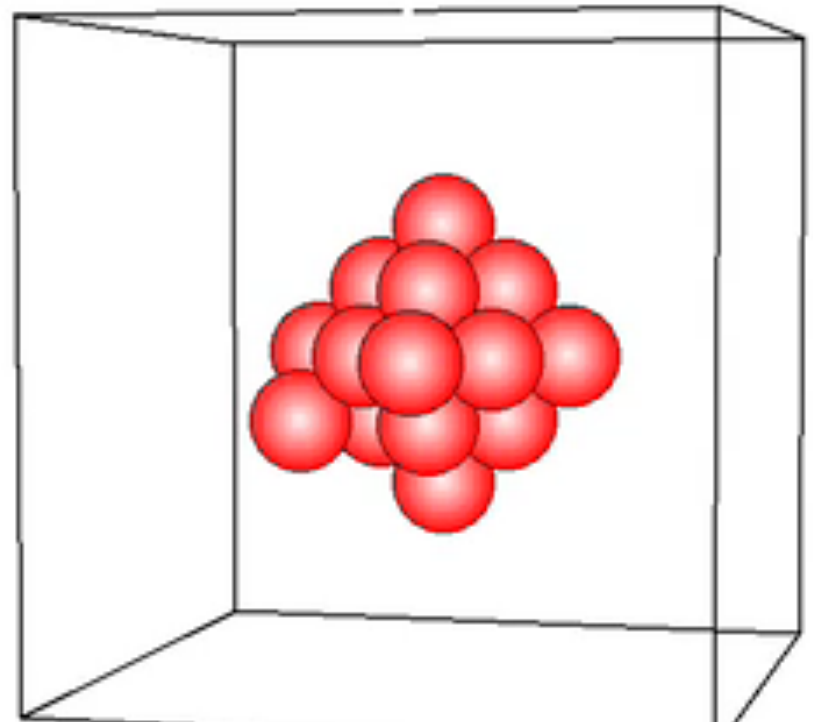
## Long time annealing of 20 vacancy void in Cu

- EAM Cu
- Parallel-replica simulation of 20-vacancy void annealing at 400 K
  - 20 vacancies is one too many for “perfect” void
- Total simulation is 7.82  $\mu\text{s}$
- At 1.69  $\mu\text{s}$ , void transforms to SFT
- Run on 39 processors for 15 days
- Efficiency = 79%
- *Equivalent single processor time: 1.3 years*



## Long time annealing of 20 vacancy void in Cu

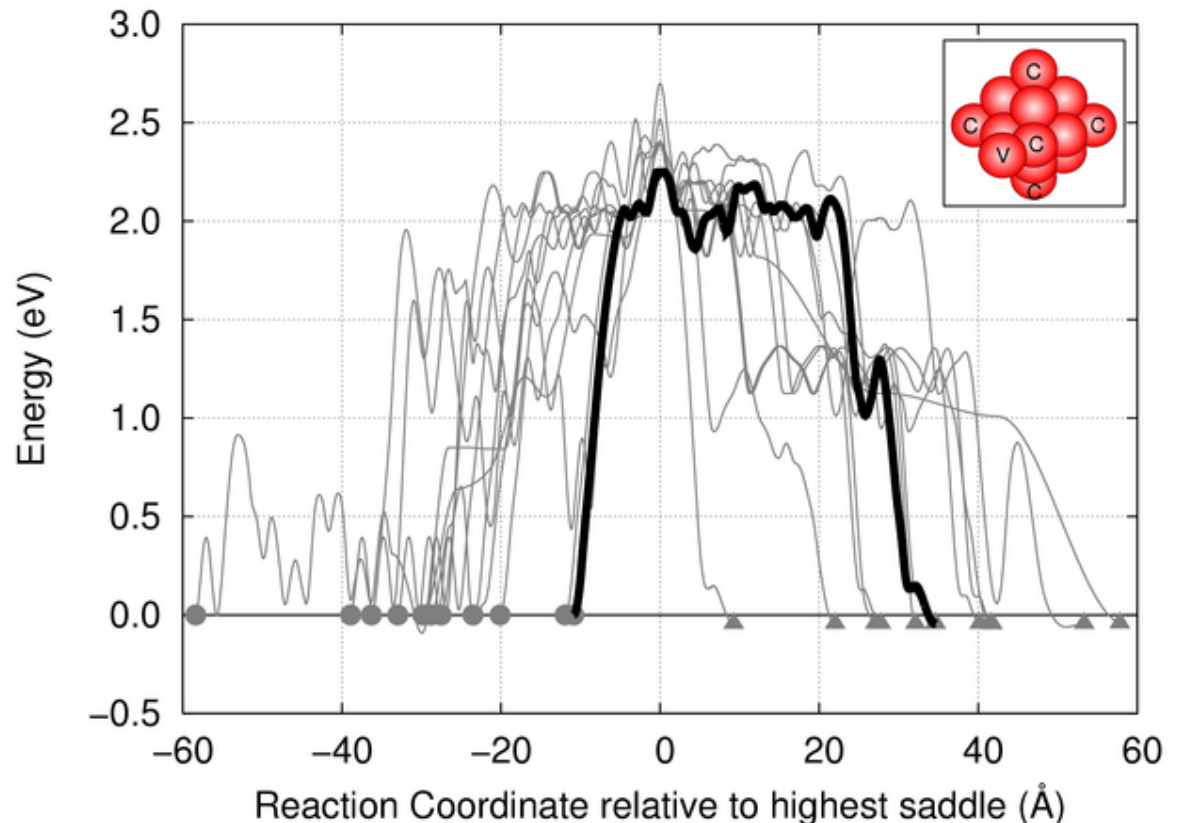
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New transformation pathway for the formation of stacking fault tetrahedra (SFTs)

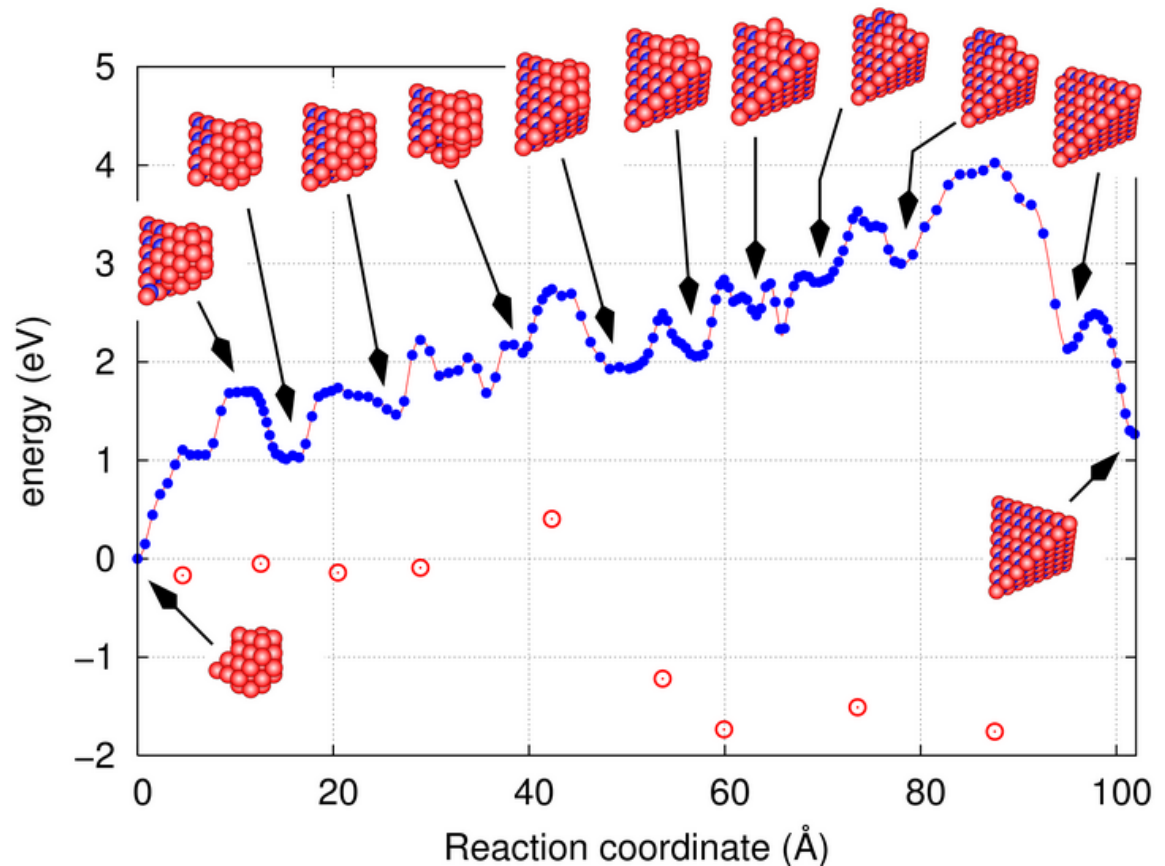
## Transformation pathway for 20 vacancy void

- Full path for transformation to SFT calculated with NEB
- Initial barrier is  $> 2$  eV
  - Should have taken  $> 10^5$  years at 400K to occur (assuming standard prefactor)
- Vineyard prefactor for first step between  $10^{36}$  and  $10^{43}$  Hz



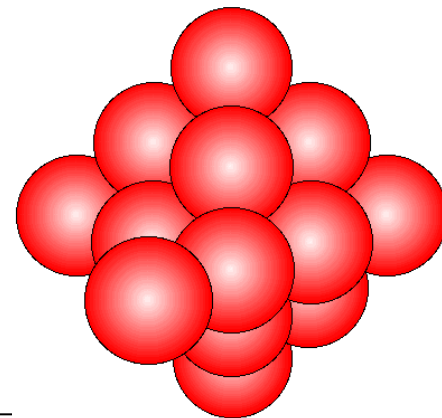
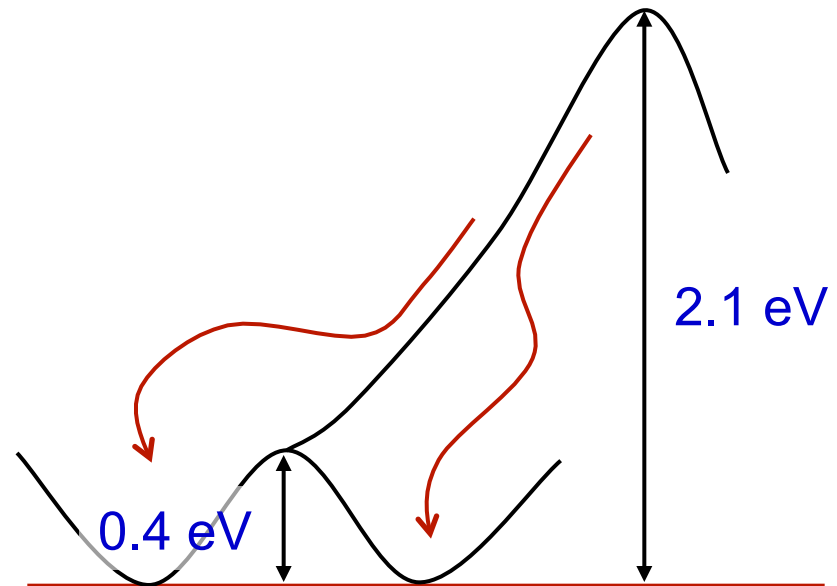
# Void to SFT transformation: 45 vacancy void in Cu

- Par-ep of 45 vacancy void at 475 K
  - 39 processors
  - 39% efficiency
  - 5.6 days
    - Effective 1 CPU time: 85 days
  - 0.24  $\mu$ s
- Figure is minimum energy path at constant volume
- Overcomes a very large internal energy barrier ( $\sim 4$  eV) at 475 K
- Free energy barrier is much lower, as estimated by open symbols



## Initial step in void to SFT transformation

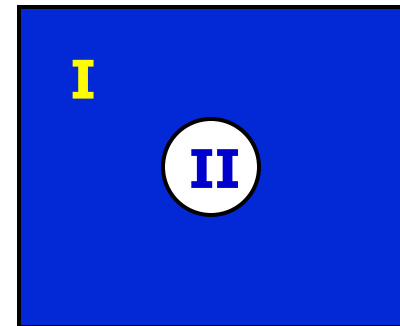
- Barrier to initiate transformation accessible from a number of states
- Part of path is a ridge, minimizing along it can land to either lower energy state
  - Problem for ensuring connectivity of saddles
- Vineyard rate for 2.1 eV process very fast
  - 144 ns at 400 K
  - *About 1 fs at 500 K*
  - Harmonic TST valid?
  - TAD valid?





## Prefactor for Transformation

- Barrier for 20-vacancy void is between 2.3 and 2.7 eV
  - Assuming a standard prefactor ( $\sim 10^{13}$  Hz), would take  $10^6$  years to occur at  $T=400$  K
  - Observed waiting times are 1-15 ns
  - Prefactor observed from dynamics:  $10^{38}$  Hz; calculated with Vineyard:  $10^{43}$  Hz
  - *Prefactor is anything but standard!*
  
- Origin of Prefactor
  - View material containing void as partitioned into two regions
    - Region I: Cu
    - Region II: void
  - Before transition, volume of Cu is Region I volume
  - After, volume of Cu is Region I + Region II
  - Entropy change  $\Delta S$  due to volume change  $\Delta V$ :  $\Delta S = \alpha B \Delta V$ 
    - $\alpha$  = coefficient of thermal expansion,  $B$  = bulk modulus
  - Assuming  $\Delta V = 10$  atomic volumes  $\Rightarrow \Delta S = 67.5/k_B \Rightarrow$  prefactor enhanced by factor of  $10^{29}$
  - Consistent with observed/calculated prefactor



## Why long time simulations were needed?

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- Once system is in corner state, time scale for void  $\rightarrow$  SFT transformation very quick, ns
- However, time to reach corner state can be very long, 1.7  $\mu$ s at 400 K
- Parallel-replica was critical for reaching time scales for surface vacancy to sample surface configurations and discover corner state
- HTST-based methods may have failed to predict mechanism

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A Temperature Accelerated Dynamics Study

# DEFECT DYNAMICS IN MgO



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# Defect Dynamics in MgO

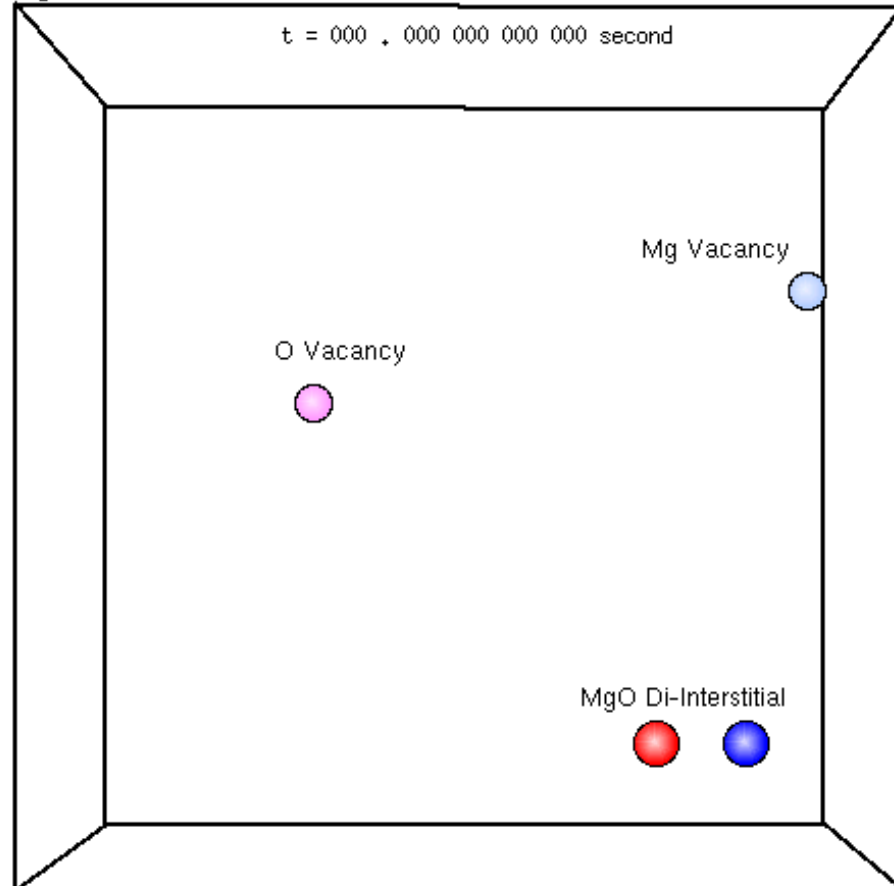
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- Goal:
  - Understand origin of radiation tolerance in complex oxides
  - Determine the relevance of metastable defects
- Methods:
  - Buckingham potential with long range electrostatics
  - MD: non-equilibrium production of damage due to irradiation
  - TAD: evolution of defects produced under irradiation
  - Rate theory: impact of atomistic defect properties on experimental observables
- References:
  - Uberuaga, Smith, Cleave, Henkelman, Grimes, Voter, and Sickafus, PRL **92**, 115505 (2004); PRB **71**, 104102 (2005); NIMB **28**, 260 (2005).

# TAD Simulation: Long-range Annihilation

- Begin with  $I_2$  and two vacancies
- $I_2$  attracted to charged vacancies, annihilating by 81 ms
- Annihilation via long range, concerted events involving many atoms
- Red=oxygen,  
Blue=magnesium
- Dark=interstitial,  
Light=vacancy

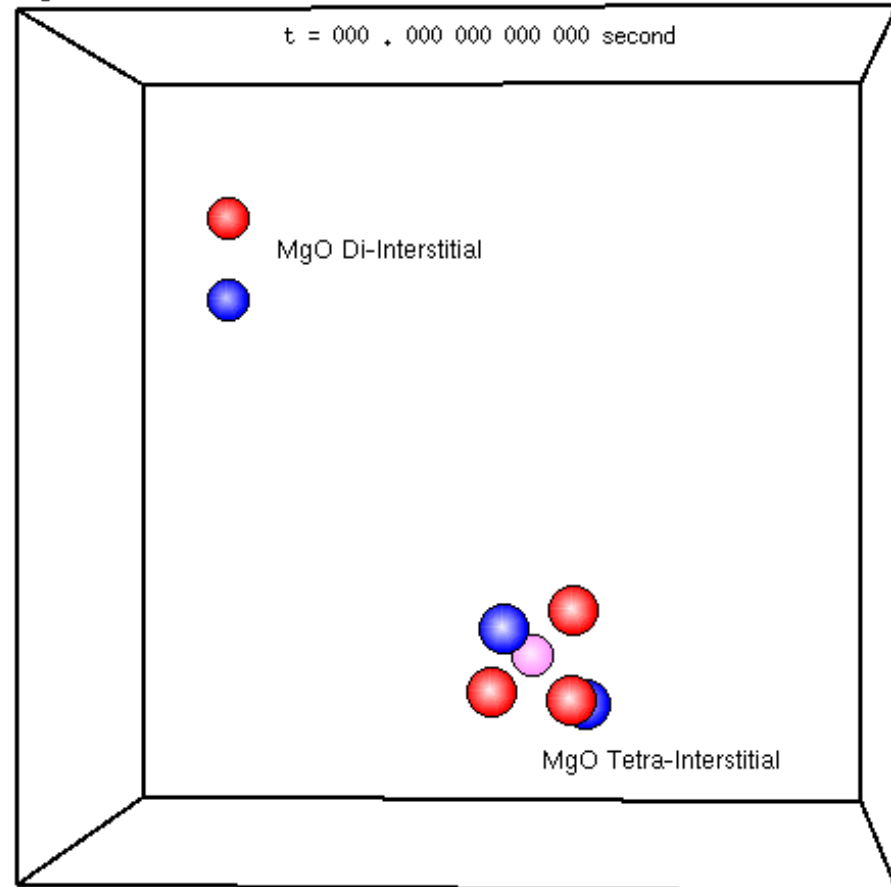
MgO: DI-Interstitial + 2 Vacancies



# Defect aggregation in MgO

- Begin with  $I_2$  and  $I_4$ 
  - Defects found at end of collision cascade
- $I_2$  attracted to  $I_4$ , binds forming  $I_6$
- Metastable  $I_6$  diffuses very quickly
  - ns timescale at 300 K
  - diffusion is 1D along  $\langle 110 \rangle$
  - decay to ground state takes years
- Red=oxygen,  
Blue=magnesium
- Dark=interstitial,  
Light=vacancy

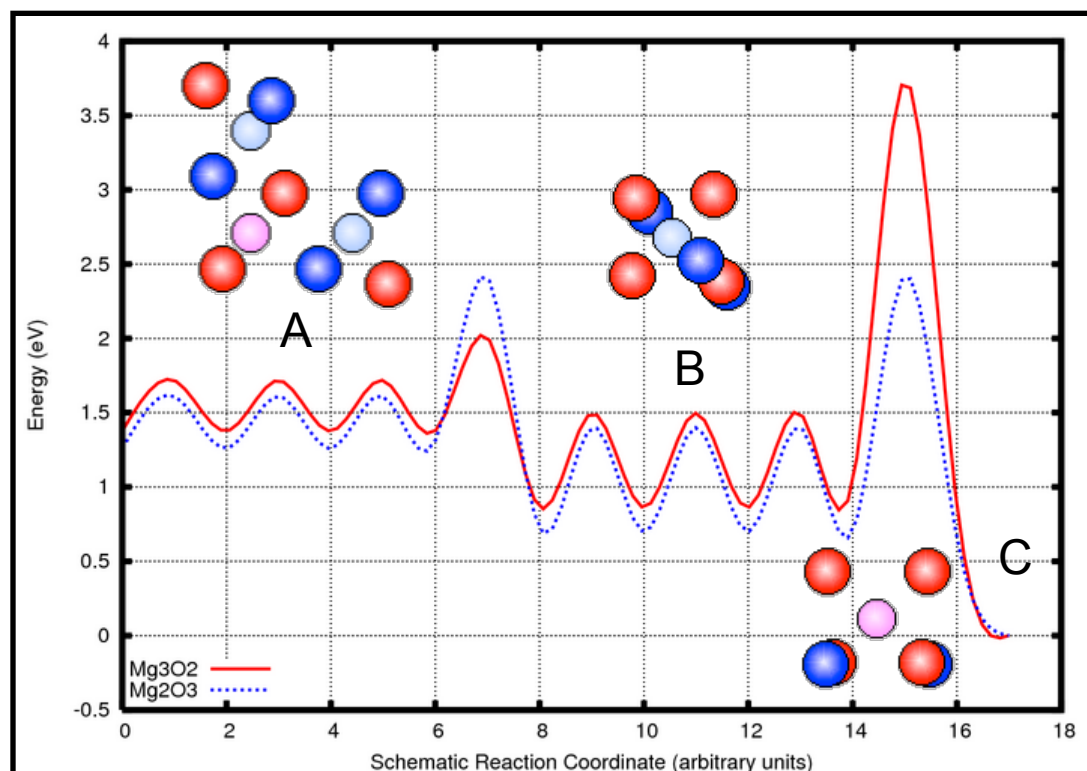
MgO: Di-Interstitial + Tetra-Interstitial



TAD simulation, Uberuaga et al, 2003

# Cluster dynamics: Kinetics of the pentamer cluster in MgO

- Two versions of pentamer:
  - $\text{Mg}_2\text{O}_3$
  - $\text{Mg}_3\text{O}_2$
- Both can exist in 3 forms
- Each has unique diffusive characteristics
  - A: diffuses quickly in  $\langle 110 \rangle$  direction
  - B: diffuses more slowly, again in  $\langle 110 \rangle$  direction
  - C: immobile at 300K
- A, B and C behave similarly for both pentamers
- But decay between forms is different

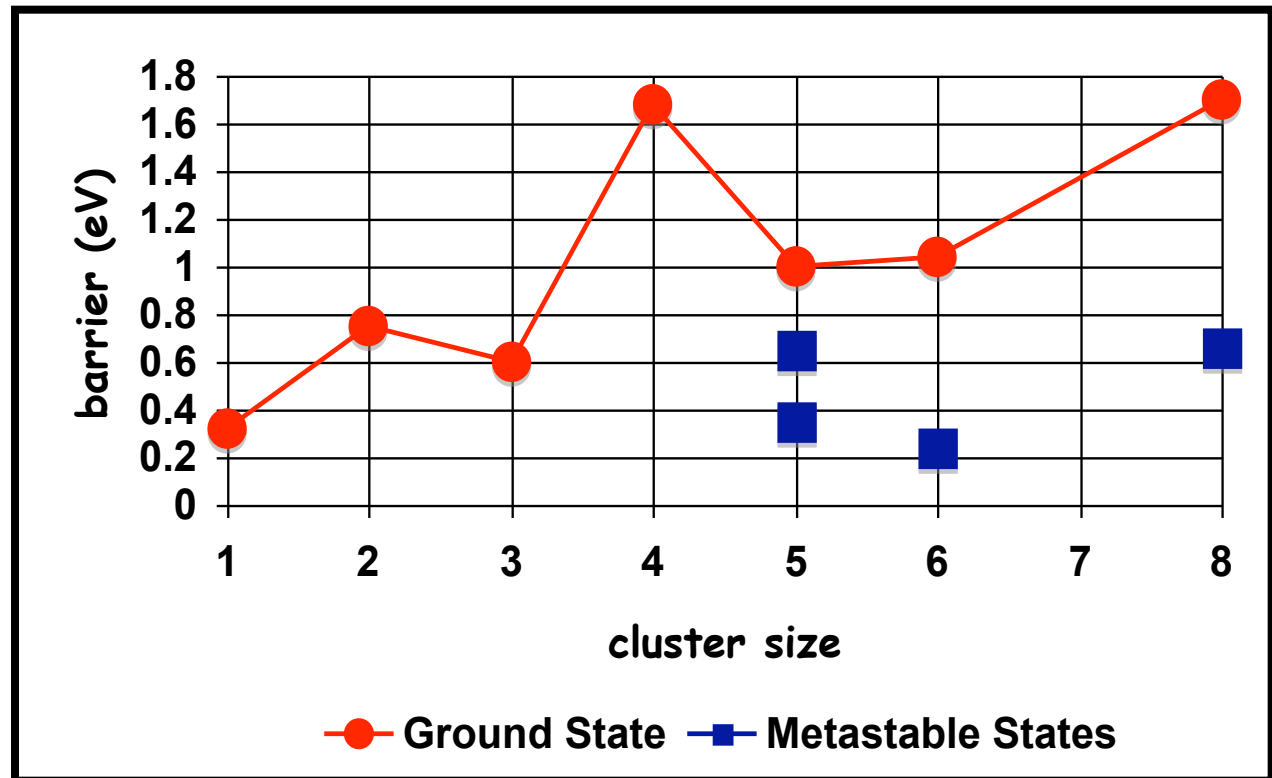


- Encounters of  $\text{MgO} + \text{MgO}_2$  can form any type of  $\text{Mg}_2\text{O}_3$ 
  - 10 simulations: 1 forms A, 7 form B, 2 form C

Uberuaga, et. al., *PRL* **92**, 115505 (2004);  
*PRB* **72**, (2005); *NIMB* **28**, 260 (2005)

# Interstitial cluster kinetics in MgO

- Diffusion barrier of ground state structures follow no clear pattern
- For clusters of size 5 and greater, there are metastable structures that diffuse faster than the ground state

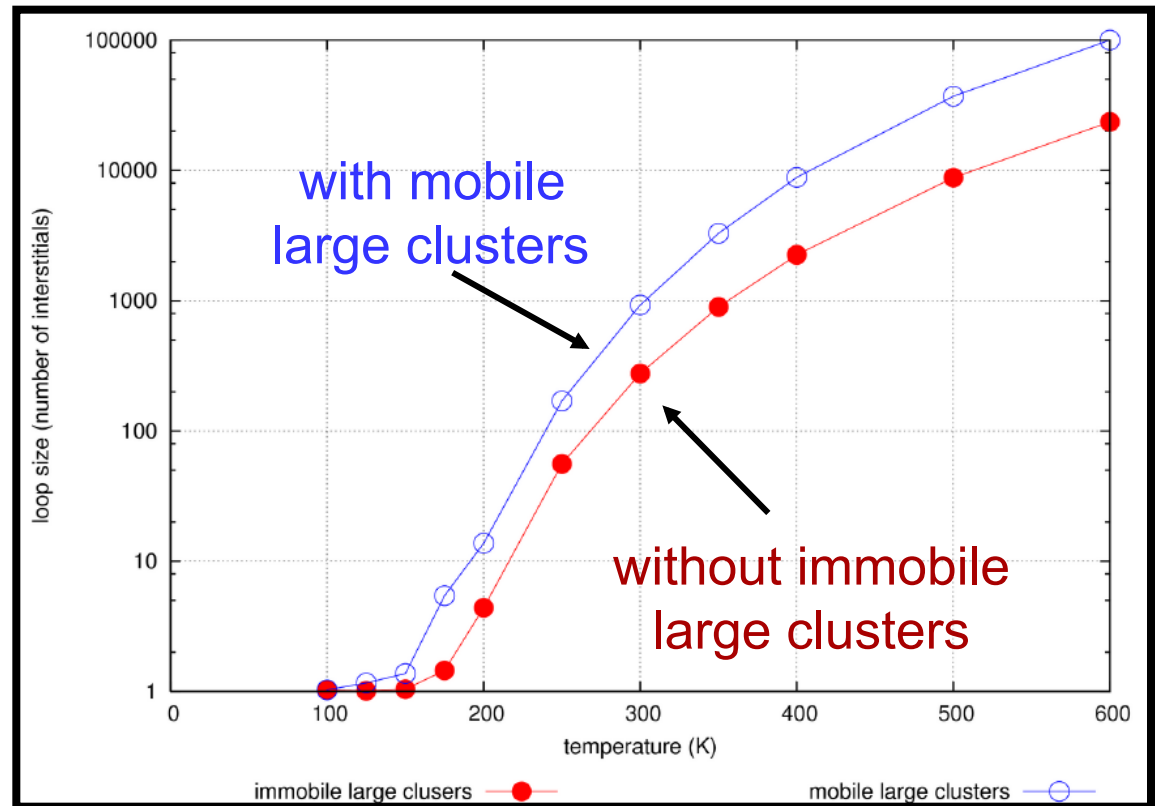


Uberuaga, et. al., *PRL* **92**, 115505 (2004);  
*PRB* **72**, (2005); *NIMB* **28**, 260 (2005)



# Effects of cluster mobility on observables

- 1-D reaction rate theory
  - Mobilities from TAD
  - Steady-state conditions
- Size of loops increases by more than 3 times when large clusters are mobile
  - “large” clusters contain more than 1 interstitial
- Enhanced defect mobility results in fewer, larger loops



Uberuaga, et. al., *PRL* **92**, 115505 (2004);  
*PRB* **72**, (2005); *NIMB* **28**, 260 (2005)

## Why long time simulations were needed?

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- TAD simulations revealed that aggregation of interstitials leads to metastable interstitial cluster structures with high mobilities
- Critical that evolution observed at low temperature as lifetime of metastable clusters at high temperature would be short and possibly missed if simply performed high-temperature MD
  - Decay barriers 0.5 – 2 eV
  - Migration barriers 0.3 – 2 eV

Two Parallel-Replica Studies

# STRAIN-RATE DEPENDENT BEHAVIOR

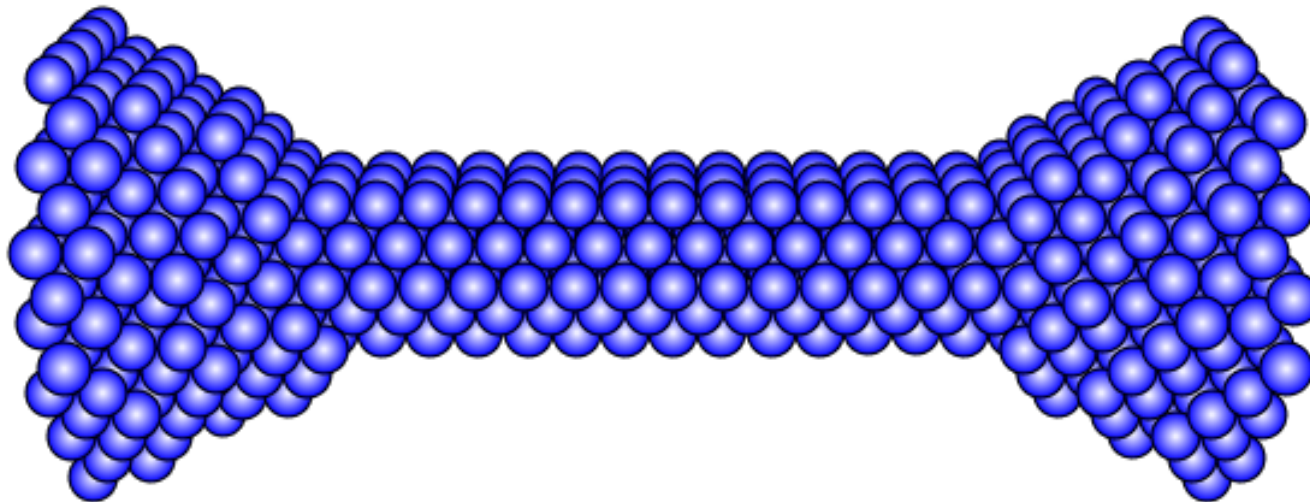


## ParRep of stretching Ag nanowire

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- Run on LANL Roadrunner (1 PFLOPS if using all 12,240 cell processors)
- Boost good at first; drops as events become more frequent.
- Outer edge atoms clamped, advanced 0.01Å at regular intervals

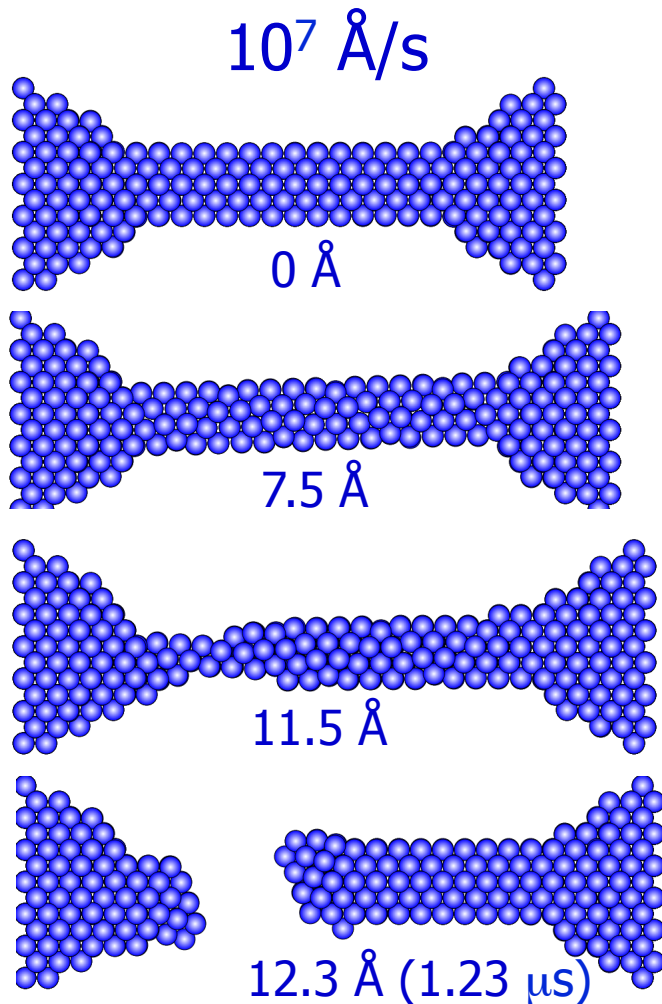
Ag[110] nanowire, 1.d5 A/s, 1 us per frame



## Pulling slower changes behavior

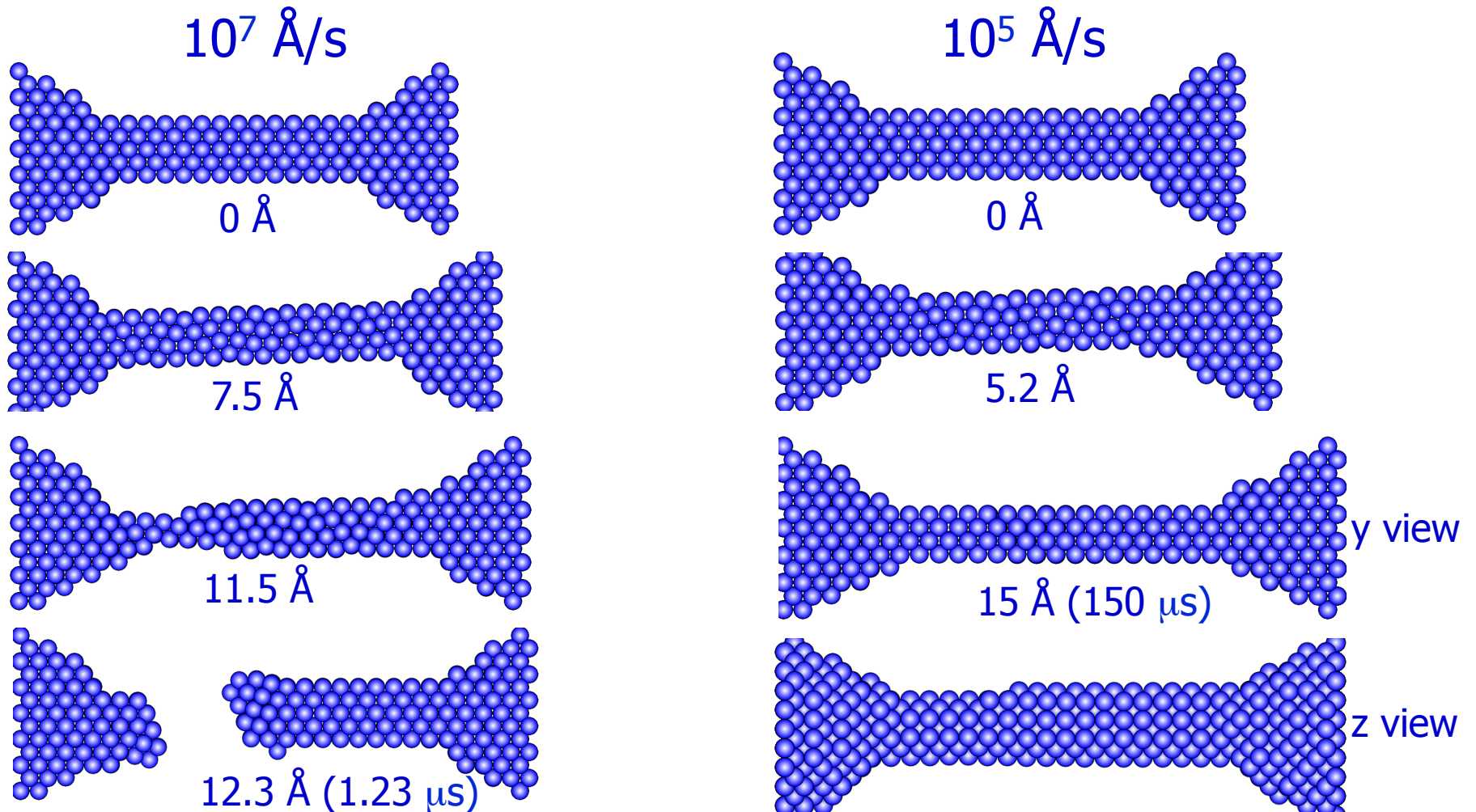
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At stretching speeds below  $\sim 10^6$  Å/s, the system can thin down, coming back to perfect fcc. At higher speeds, it disorders or necks, never recovering perfect fcc.



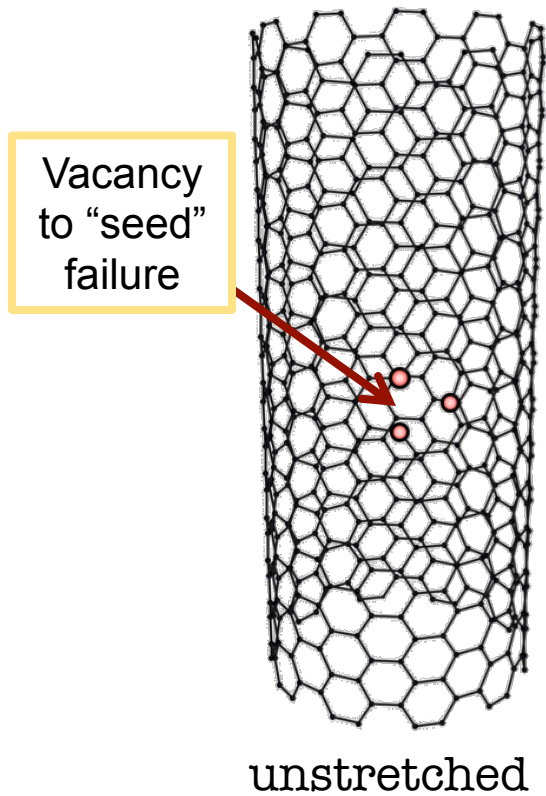
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# ParRep of stretched nanotubes

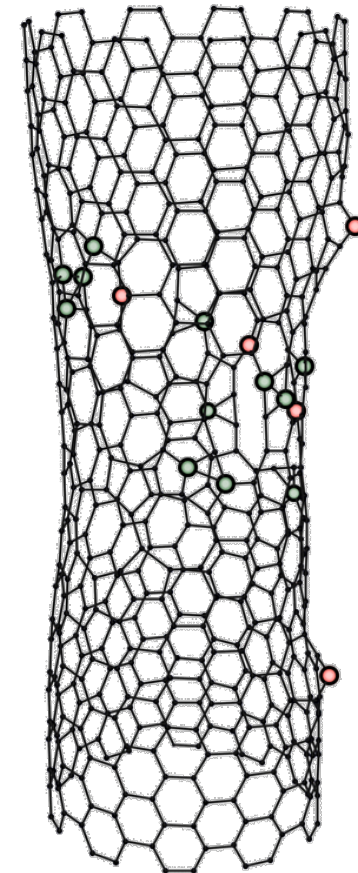
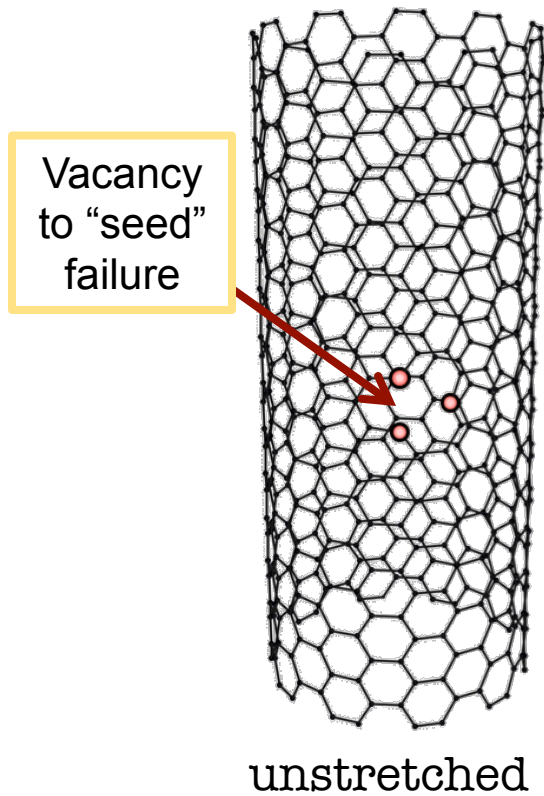
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red=undercoordinated atoms  
green=overcoordinated atoms

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# ParRep of stretched nanotubes



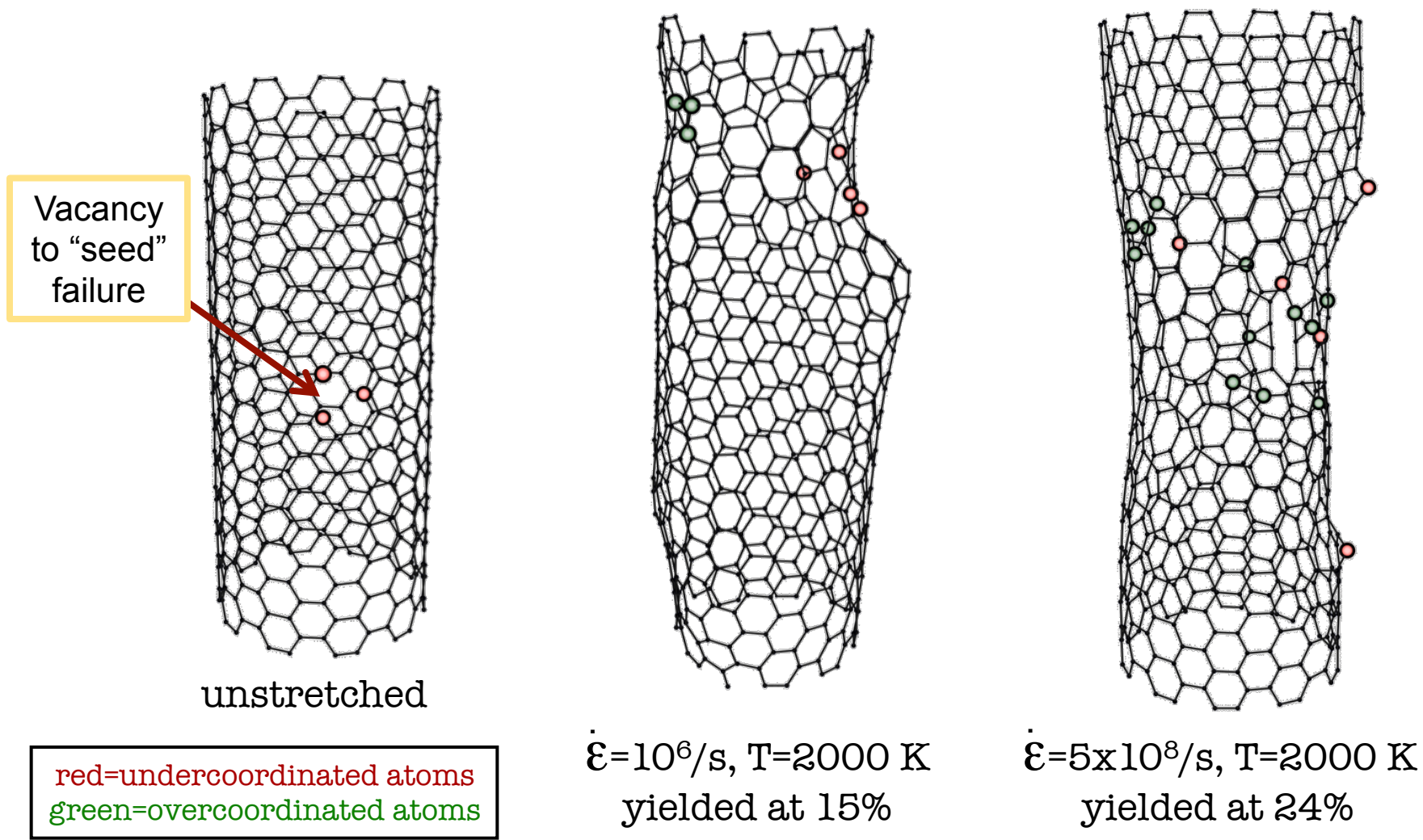
$\dot{\epsilon} = 5 \times 10^8 / \text{s}$ ,  $T = 2000 \text{ K}$   
yielded at 24%

red=undercoordinated atoms  
green=overcoordinated atoms

EST. 1943

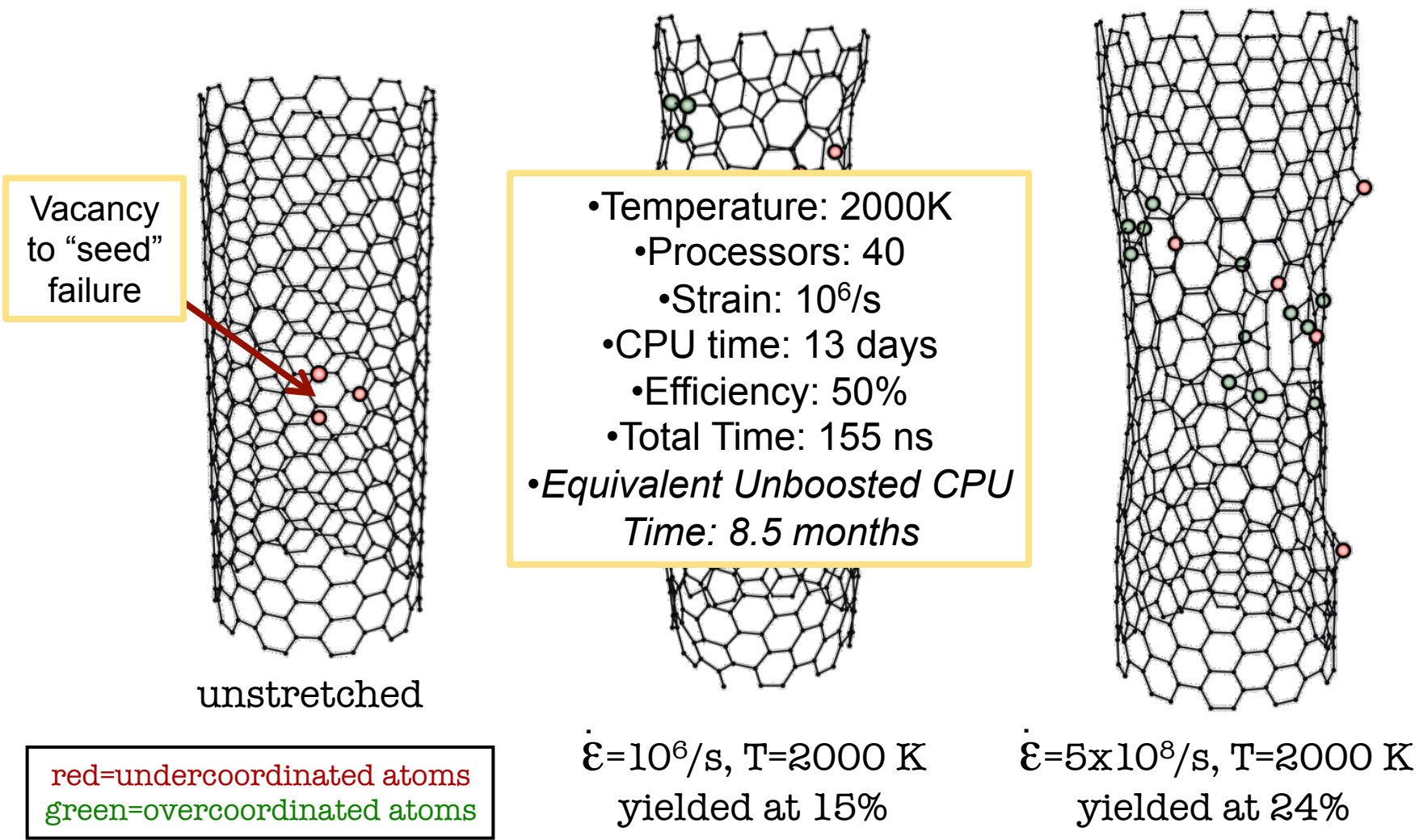


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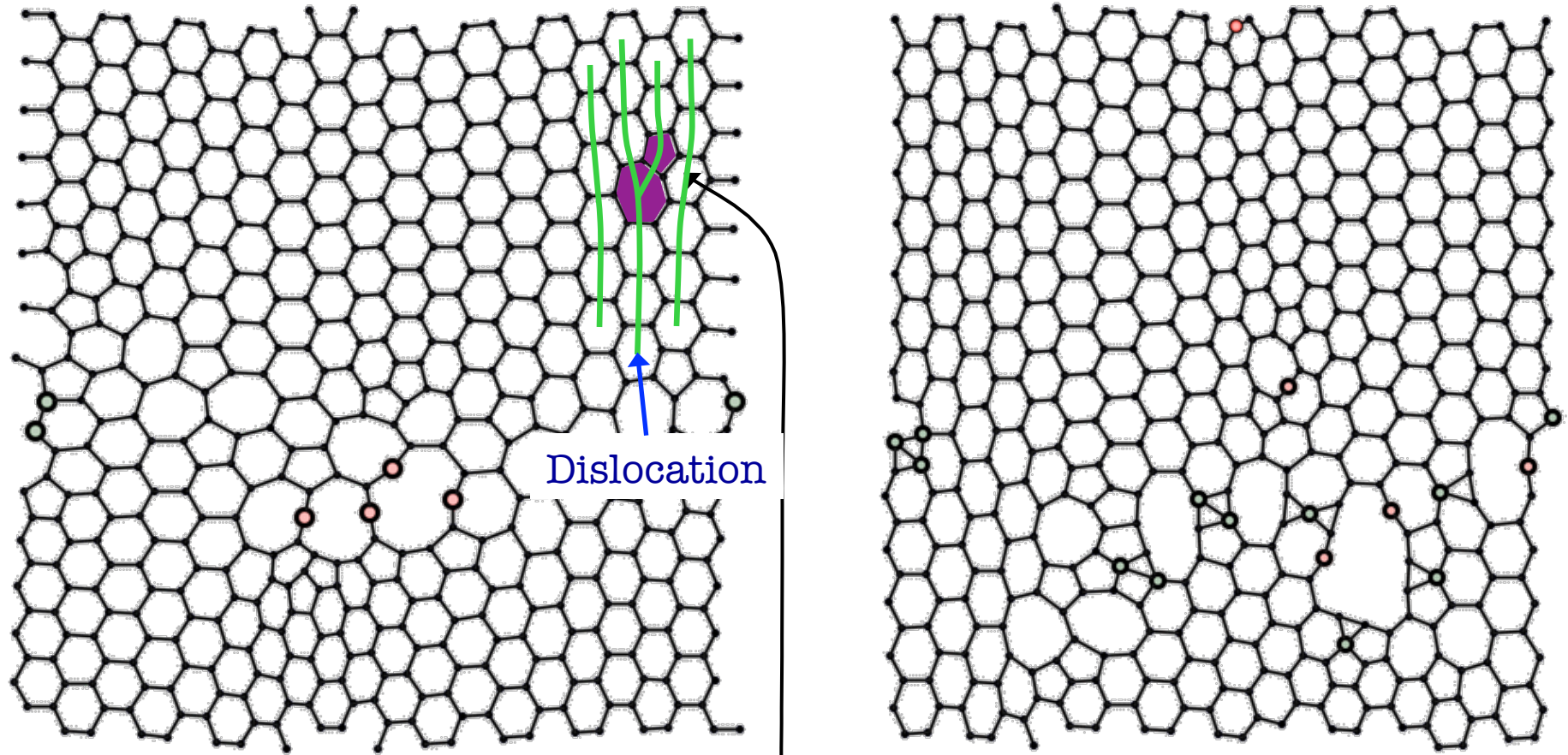
EST. 1943

# ParRep of stretched nanotubes



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## Structure of Nanotubes after Yield

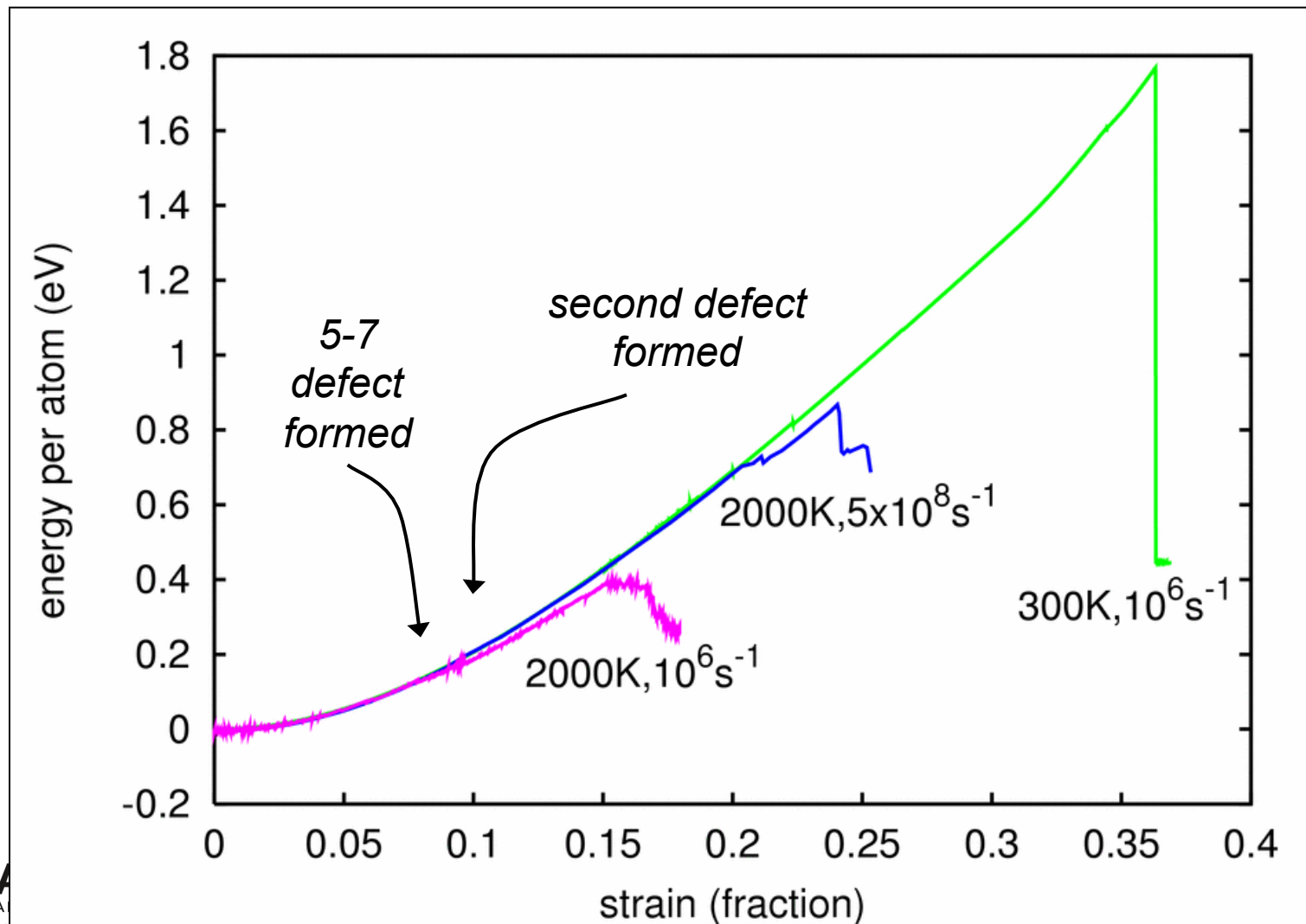


Strain rate:  $10^6/s$

5-7  
defect

Strain rate:  $5 \times 10^8/s$

# Energy vs Strain for Nanotube with a Vacancy



## Why long time simulations were needed?

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- In both nanowire and nanotube, new processes occur as strain rate is decreased
- These processes relieve strain in a qualitatively differently manner than in over-driven cases
- Observation of these processes depends on reducing strain rates by reaching longer time scales

## Summary

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- AMD methods allow the study of processes not accessible to MD
- Often, results are very surprising
  - Many mechanisms that would be left out of e.g. KMC if intuition alone is used
  - New insights into kinetic processes, even in the simplest of materials

➔ Probing long-time kinetics is crucial for understanding material evolution in complex environments